STP160N4LF6



N-channel 40 V, 0.0021 mΩ typ., 120 A, STripFET™ VI DeepGATE™ Power MOSFET in a TO-220 package

Datasheet - production data

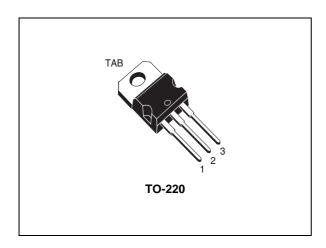
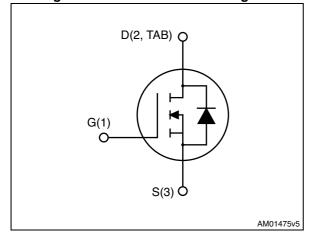


Figure 1. Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max | I _D | P _{TOT} |
|-------------|-----------------|-------------------------|----------------|------------------|
| STP160N4LF6 | 40 V | $0.0029~\Omega$ | 120 A | 150 W |

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Logic level drive
- High avalanche ruggedness
- 100% avalanche tested

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using the 6^{th} generation of STripFET™ DeepGATE™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest $R_{DS(on)}$ in all packages.

Table 1. Device summary

| Order code | Marking | Package | Packaging |
|-------------|----------|---------|-----------|
| STP160N4LF6 | 160N4LF6 | TO-220 | Tube |

Contents STP160N4LF6

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STP160N4LF6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|--|------------|------|
| V _{DS} | Drain-source voltage | 40 | V |
| V _{GS} | Gate-source voltage | ± 20 | V |
| I _D | Drain current (continuous) at T _C = 25 °C | 120 | Α |
| I _D | Drain current (continuous) at T _C = 100 °C | 100 | Α |
| I _{DM} ⁽¹⁾ | Drain current (pulsed) | 480 | Α |
| P _{TOT} | Total dissipation at T _C = 25 °C | 150 | W |
| | Derating factor | 1 | W/°C |
| I _{AS} | Avalanche current, repetitive or not-repetitive (pulse width limited by T_{jmax}) | 60 | А |
| E _{AS} | Single pulse avalanche energy | 323 | mJ |
| T _{stg} | Storage temperature | -55 to 175 | |
| T _j | Operating junction temperature | -55 10 175 | °C |

^{1.} Pulse width is limited by safe operating area

Table 3. Thermal resistance

| Symbol | Parameter | Value | Unit |
|-----------------------|---|-------|------|
| R _{thj-case} | Thermal resistance junction-case max | 1.0 | °C/W |
| R _{thj-a} | Thermal resistance junction-ambient max | 62.5 | °C/W |

Electrical characteristics STP160N4LF6

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified).

Table 4. Static

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|---|---|------|--------|---------|----------|
| V _{(BR)DSS} | Drain-source breakdown voltage (V _{GS} = 0) | I _D = 250 μA | 40 | | | V |
| I _{DSS} | Zero gate voltage drain current (V _{GS} = 0) | V _{DS} = 20 V V _{DS} = 20 V, Tc = 125 °C | | | 1 10 | μA μA |
| I _{GSS} | Gate body leakage current (V _{DS} = 0) | V _{GS} = ± 20 V | | | ±100 | nA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1 | | | V |
| B | Static drain-source on- | $V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$ | | 0.0022 | 0.0029 | Ω |
| R _{DS(on)} | resistance | $V_{GS} = 5 \text{ V}, I_D = 60 \text{ A}$ | | 0.0024 | 0.0031 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min | Тур. | Max. | Unit |
|------------------|------------------------------|---|-----|------|------|------|
| C _{iss} | Input capacitance | | - | 8130 | - | pF |
| C _{oss} | Output capacitance | $V_{DS} = 20 \text{ V, f=1 MHz,}$ $V_{GS} = 0 \text{ V}$ | - | 770 | - | pF |
| C _{rss} | Reverse transfer capacitance | | - | 670 | - | pF |
| Qg | Total gate charge | V _{DD} = 20 V, I _D = 60 A | - | 181 | - | nC |
| Q _{gs} | Gate-source charge | V _{GS} = 10 V | - | 22 | - | nC |
| Q _{gd} | Gate-drain charge | (see Figure 14) | - | 46 | - | nC |

Table 6. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| t _{d(on)} | Turn-on delay time | $V_{DD} = 20 \text{ V}, I_{D} = 60 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 15) | - | 20 | - | ns |
| t _r | Rise time | | - | 131 | - | ns |
| t _{d(off)} | Turn-off delay time | | - | 205 | - | ns |
| t _f | Fall time | , | - | 116 | | ns |

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|---|--|------|------|------|------|
| I _{SD} | Source-drain current | | - | | 120 | Α |
| I _{SDM} ⁽¹⁾ | Source-drain current (pulsed) | | - | | 480 | Α |
| V _{SD} ⁽²⁾ | Forward on voltage | I _{SD} = 120 A, V _{GS} = 0 | - | | 0.97 | ٧ |
| t _{rr} | Reverse recovery time | I _{SD} = 120 A, | - | 57 | | ns |
| Q _{rr} | Reverse recovery charge $\frac{\text{di/dt} = 100 \text{ A/}\mu\text{s}}{\text{V}} = \frac{32 \text{ V}}{\text{V}}$ | | - | 53 | | nC |
| I _{RRM} | Reverse recovery current | V _{DD} = 32 V (see Figure 17) | - | 1.86 | | Α |

- 1. Pulse width limited by safe operating area
- 2. Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STP160N4LF6

Electrical characteristics (curves) 2.1

Figure 2. Safe operating area

AM15806v1 (A) Tj=175°C Single pulse 100 100 µs 1ms 10 10ms 0.1 10 V_{DS}(V)

Figure 3. Thermal impedance

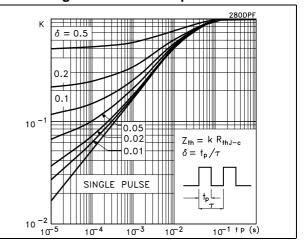


Figure 4. Output characteristics

AM15797v1 ΙD V_{GS}= 6, 7, 8, 9, 10 V V_{GS}= 5 V 250 V_{GS}= 4 V 200 150 100 50 V_{GS}= 3 V 0 0.2 0.4 0.6 8.0 V_{DS}(V)

Figure 5. Transfer characteristics

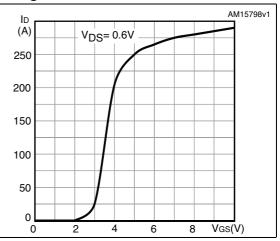
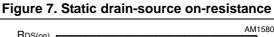
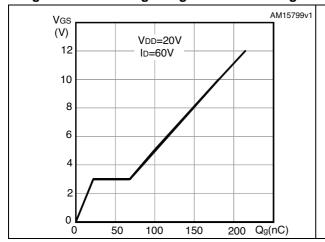
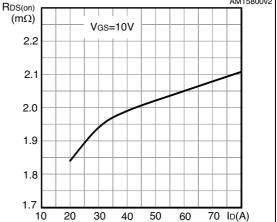


Figure 6. Gate charge vs gate-source voltage





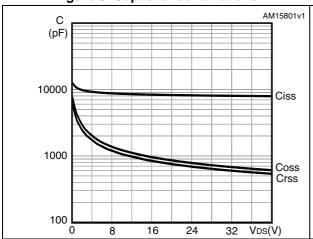


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O

Figure 8. Capacitance variations

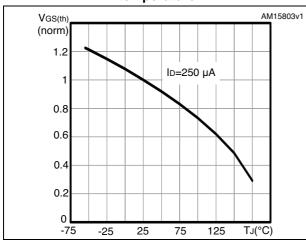
Figure 9. Normalized V_{(BR)DSS} vs temperature



AM15802v1 V(BR)DSS (norm) ID=250 μA 1.08 1.06 1.04 1.02 0.98 0.96 0.94 0.92**L** -75 -25 25 75 125 TJ(°C)

Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



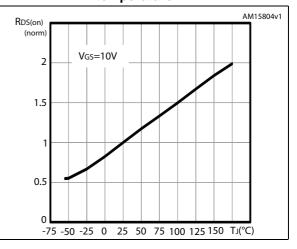
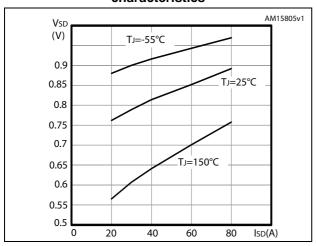


Figure 12. Source-drain diode forward characteristics



Test circuits STP160N4LF6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

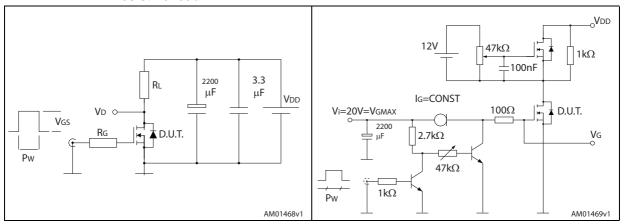


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

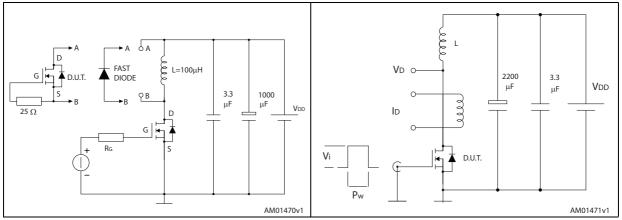
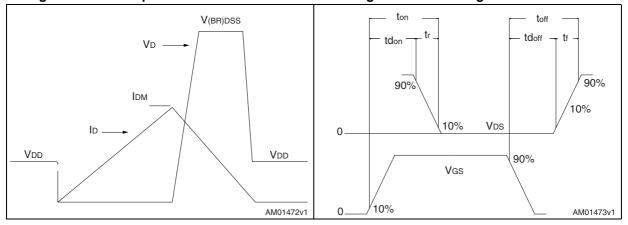


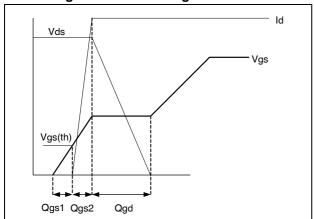
Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



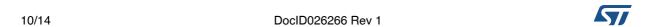
STP160N4LF6 Test circuits

Figure 19. Gate charge waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



øΡ Ε H1 D <u>D1</u> L20 L30 b1(X3) -- b (X3) _e1___ 0015988_typeA_Rev_T

Figure 20. TO-220 type A drawing

Table 8. TO-220 type A mechanical data

| Dim | | mm | |
|------|-------|-------|-------|
| Dim. | Min. | Тур. | Max. |
| А | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| С | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| Е | 10 | | 10.40 |
| е | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

STP160N4LF6 Revision history

5 Revision history

Table 9. Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 24-Apr-2014 | 1 | First release. |

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